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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

| | |
|----------------------------|---|
| Product Status | Active |
| Core Processor | PIC |
| Core Size | 8-Bit |
| Speed | 4MHz |
| Connectivity | - |
| Peripherals | POR, WDT |
| Number of I/O | 5 |
| Program Memory Size | 768B (512 x 12) |
| Program Memory Type | FLASH |
| EEPROM Size | - |
| RAM Size | 25 x 8 |
| Voltage - Supply (Vcc/Vdd) | 2V ~ 5.5V |
| Data Converters | - |
| Oscillator Type | Internal |
| Operating Temperature | -40°C ~ 85°C (TA) |
| Mounting Type | Through Hole |
| Package / Case | 8-DIP (0.300", 7.62mm) |
| Supplier Device Package | 8-PDIP |
| Purchase URL | https://www.e-xfl.com/product-detail/microchip-technology/pic12f508-i-p |

1.0 GENERAL DESCRIPTION

The PIC12F508/509/16F505 devices from Microchip Technology are low-cost, high-performance, 8-bit, fully-static, Flash-based CMOS microcontrollers. They employ a RISC architecture with only 33 single-word/single-cycle instructions. All instructions are single cycle (200 μ s) except for program branches, which take two cycles. The PIC12F508/509/16F505 devices deliver performance an order of magnitude higher than their competitors in the same price category. The 12-bit wide instructions are highly symmetrical, resulting in a typical 2:1 code compression over other 8-bit microcontrollers in its class. The easy to use and easy to remember instruction set reduces development time significantly.

The PIC12F508/509/16F505 products are equipped with special features that reduce system cost and power requirements. The Power-on Reset (POR) and Device Reset Timer (DRT) eliminate the need for external Reset circuitry. There are four oscillator configurations to choose from (six on the PIC16F505), including INTRC Internal Oscillator mode and the power-saving LP (Low-Power) Oscillator mode. Power-Saving Sleep mode, Watchdog Timer and code protection features improve system cost, power and reliability.

The PIC12F508/509/16F505 devices are available in the cost-effective Flash programmable version, which is suitable for production in any volume. The customer can take full advantage of Microchip's price leadership in Flash programmable microcontrollers, while benefiting from the Flash programmable flexibility.

The PIC12F508/509/16F505 products are supported by a full-featured macro assembler, a software simulator, an in-circuit emulator, a 'C' compiler, a low-cost development programmer and a full featured programmer. All the tools are supported on IBM® PC and compatible machines.

1.1 Applications

The PIC12F508/509/16F505 devices fit in applications ranging from personal care appliances and security systems to low-power remote transmitters/receivers. The Flash technology makes customizing application programs (transmitter codes, appliance settings, receiver frequencies, etc.) extremely fast and convenient. The small footprint packages, for through hole or surface mounting, make these microcontrollers perfect for applications with space limitations. Low cost, low power, high performance, ease-of-use and I/O flexibility make the PIC12F508/509/16F505 devices very versatile even in areas where no microcontroller use has been considered before (e.g., timer functions, logic and PLDs in larger systems and coprocessor applications).

TABLE 1-1: PIC12F508/509/16F505 DEVICES

| | | PIC12F508 | PIC12F509 | PIC16F505 |
|-------------|--------------------------------------|-----------------------------|-----------------------------|--------------------------|
| Clock | Maximum Frequency of Operation (MHz) | 4 | 4 | 20 |
| Memory | Flash Program Memory (words) | 512 | 1024 | 1024 |
| | Data Memory (bytes) | 25 | 41 | 72 |
| Peripherals | Timer Module(s) | TMR0 | TMR0 | TMR0 |
| | Wake-up from Sleep on Pin Change | Yes | Yes | Yes |
| Features | I/O Pins | 5 | 5 | 11 |
| | Input Pins | 1 | 1 | 1 |
| | Internal Pull-ups | Yes | Yes | Yes |
| | In-Circuit Serial Programming | Yes | Yes | Yes |
| | Number of Instructions | 33 | 33 | 33 |
| | Packages | 8-pin PDIP, SOIC, MSOP, DFN | 8-pin PDIP, SOIC, MSOP, DFN | 14-pin PDIP, SOIC, TSSOP |

The PIC12F508/509/16F505 devices have Power-on Reset, selectable Watchdog Timer, selectable code-protect, high I/O current capability and precision internal oscillator.

The PIC12F508/509/16F505 devices use serial programming with data pin RB0/GP0 and clock pin RB1/GP1.

PIC12F508/509/16F505

NOTES:

PIC12F508/509/16F505

TABLE 3-3: PIC16F505 PINOUT DESCRIPTION

| Name | Function | Input Type | Output Type | Description |
|-----------------|----------|------------|-------------|---|
| RB0/ICSPDAT | RB0 | TTL | CMOS | Bidirectional I/O pin. Can be software programmed for internal weak pull-up and wake-up from Sleep on pin change. |
| | ICSPDAT | ST | CMOS | In-Circuit Serial Programming™ data pin. |
| RB1/ICSPCLK | RB1 | TTL | CMOS | Bidirectional I/O pin. Can be software programmed for internal weak pull-up and wake-up from Sleep on pin change. |
| | ICSPCLK | ST | CMOS | In-Circuit Serial Programming clock pin. |
| RB2 | RB2 | TTL | CMOS | Bidirectional I/O pin. |
| RB3/MCLR/VPP | RB3 | TTL | — | Input port. Can be software programmed for internal weak pull-up and wake-up from Sleep on pin change. |
| | MCLR | ST | — | Master Clear (Reset). When configured as MCLR, this pin is an active-low Reset to the device. Voltage on MCLR/VPP must not exceed VDD during normal device operation or the device will enter Programming mode. Weak pull-up always on if configured as MCLR. |
| | VPP | HV | — | Programming voltage input. |
| RB4/OSC2/CLKOUT | RB4 | TTL | CMOS | Bidirectional I/O pin. Can be software programmed for internal weak pull-up and wake-up from Sleep on pin change. |
| | OSC2 | — | XTAL | Oscillator crystal output. Connections to crystal or resonator in Crystal Oscillator mode (XT, HS and LP modes only). |
| | CLKOUT | — | CMOS | In EXTRC and INTRC modes, the pin output can be configured for CLKOUT, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate. |
| RB5/OSC1/CLKIN | RB5 | TTL | CMOS | Bidirectional I/O pin. |
| | OSC1 | XTAL | — | Crystal input. |
| | CLKIN | ST | — | External clock source input. |
| RC0 | RC0 | TTL | CMOS | Bidirectional I/O pin. |
| RC1 | RC1 | TTL | CMOS | Bidirectional I/O pin. |
| RC2 | RC2 | TTL | CMOS | Bidirectional I/O pin. |
| RC3 | RC3 | TTL | CMOS | Bidirectional I/O pin. |
| RC4 | RC4 | TTL | CMOS | Bidirectional I/O pin. |
| RC5/T0CKI | RC5 | TTL | CMOS | Bidirectional I/O pin. |
| | T0CKI | ST | — | Clock input to TMR0. |
| VDD | VDD | — | P | Positive supply for logic and I/O pins. |
| VSS | VSS | — | P | Ground reference for logic and I/O pins. |

Legend: I = Input, O = Output, I/O = Input/Output, P = Power, — = Not used, TTL = TTL input, ST = Schmitt Trigger input, HV = High Voltage

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3.1 Clocking Scheme/Instruction Cycle

The clock input (OSC1/CLKIN pin) is internally divided by four to generate four non-overlapping quadrature clocks, namely Q1, Q2, Q3 and Q4. Internally, the PC is incremented every Q1 and the instruction is fetched from program memory and latched into the instruction register in Q4. It is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow is shown in Figure 3-3 and Example 3-1.

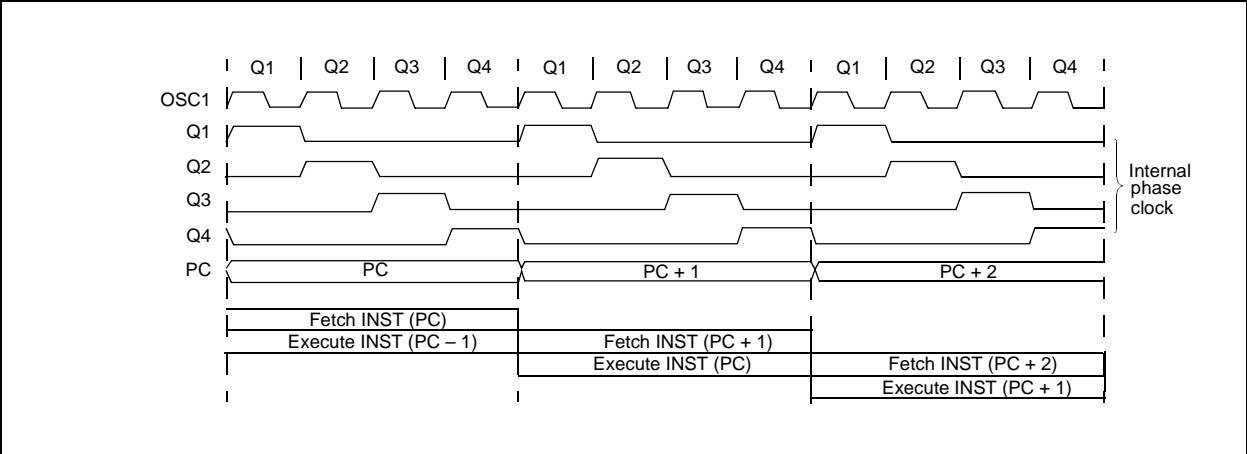
3.2 Instruction Flow/Pipelining

An instruction cycle consists of four Q cycles (Q1, Q2, Q3 and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle, while decode and execute take another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the PC to change (e.g., GOTO), then two cycles are required to complete the instruction (Example 3-1).

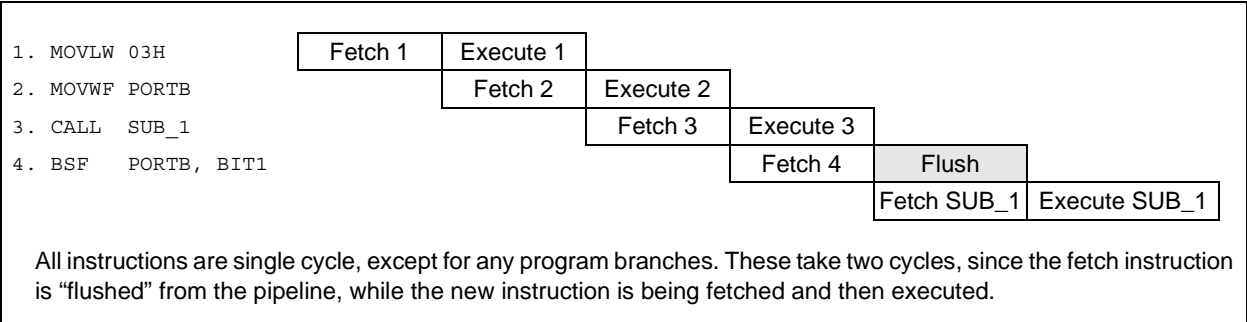
A fetch cycle begins with the PC incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the Instruction Register (IR) in cycle Q1. This instruction is then decoded and executed during the Q2, Q3 and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

FIGURE 3-3: CLOCK/INSTRUCTION CYCLE



EXAMPLE 3-1: INSTRUCTION PIPELINE FLOW



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FIGURE 4-3: PIC12F508 REGISTER FILE MAP

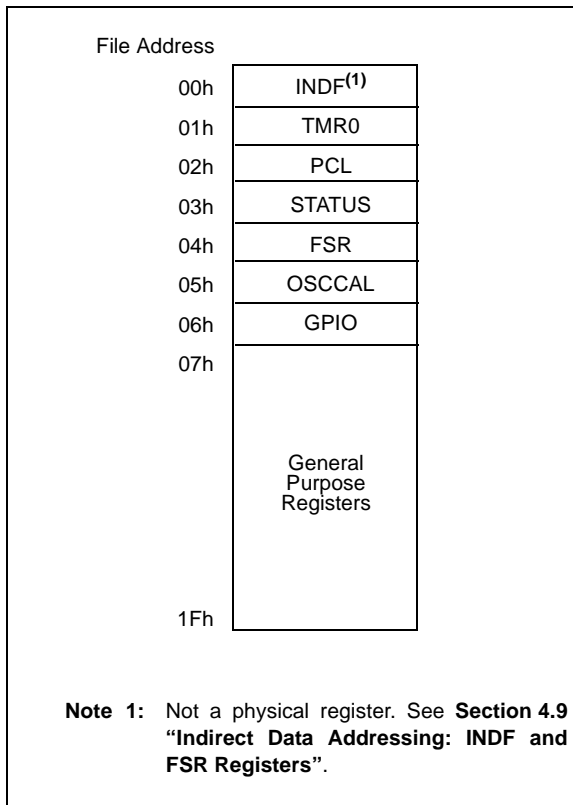


FIGURE 4-4: PIC12F509 REGISTER FILE MAP

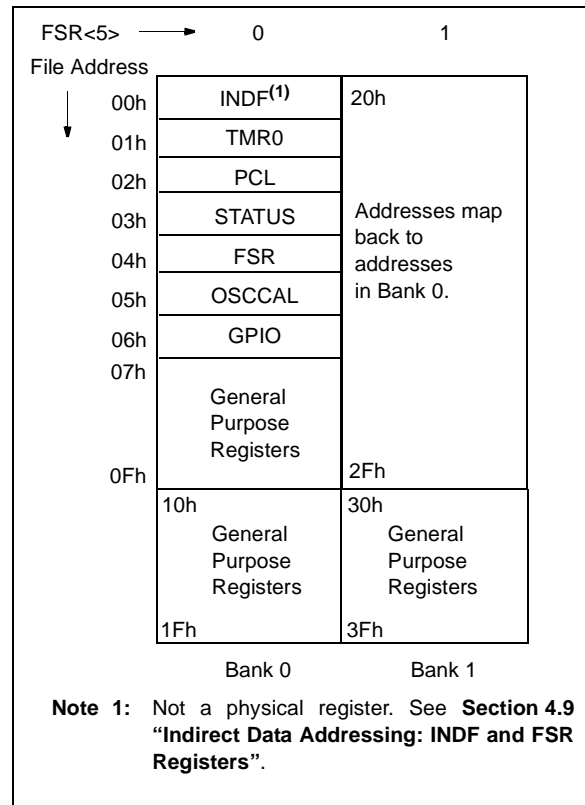
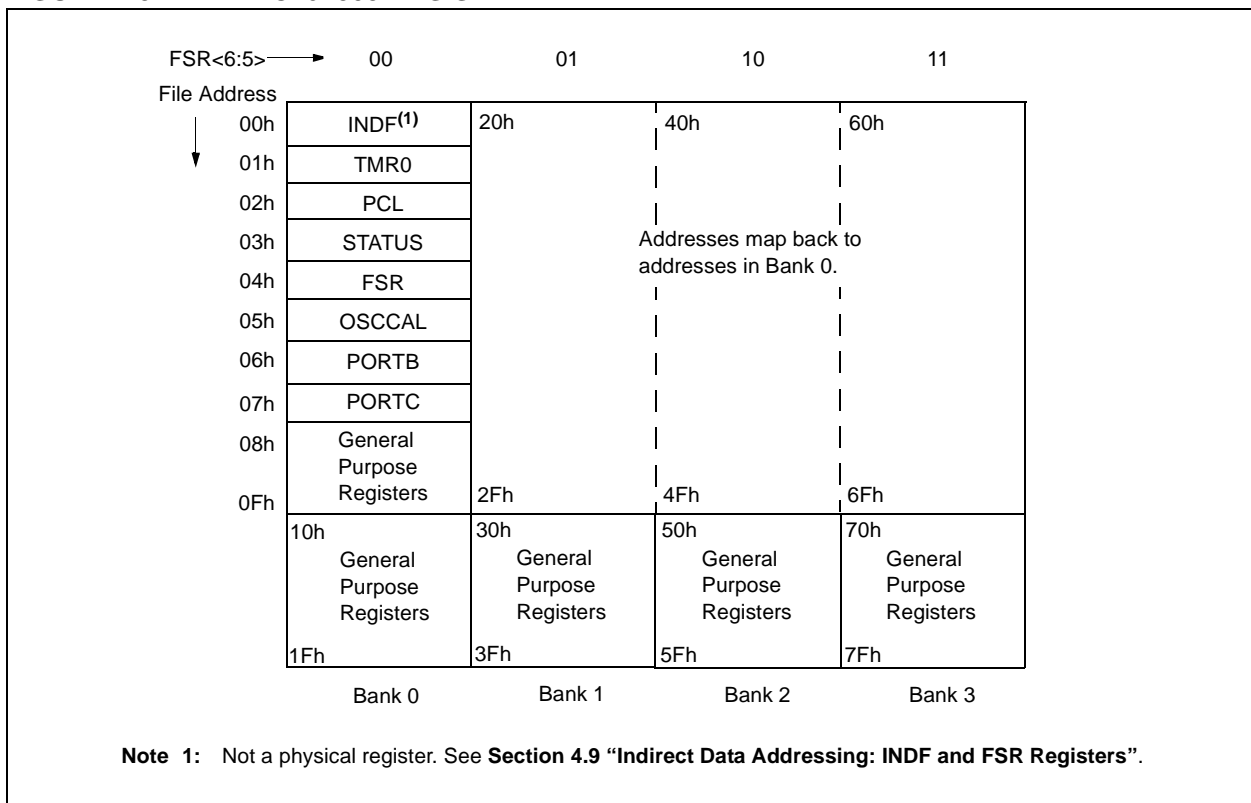


FIGURE 4-5: PIC16F505 REGISTER FILE MAP



PIC12F508/509/16F505

REGISTER 4-4: OPTION REGISTER (PIC16F505)

| | | | | | | | |
|-------------|-------------|------|------|-----|-----|-----|-------|
| W-1 | W-1 | W-1 | W-1 | W-1 | W-1 | W-1 | W-1 |
| <u>RBWU</u> | <u>RBPU</u> | T0CS | T0SE | PSA | PS2 | PS1 | PS0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 7 **RBWU**: Enable Wake-up on Pin Change bit (RB0, RB1, RB3, RB4)

1 = Disabled

0 = Enabled

bit 6 **RBPU**: Enable Weak Pull-ups bit (RB0, RB1, RB3, RB4)

1 = Disabled

0 = Enabled

bit 5 **T0CS**: Timer0 clock Source Select bit

1 = Transition on T0CKI pin (overrides TRIS on the T0CKI pin)

0 = Transition on internal instruction cycle clock, Fosc/4

bit 4 **T0SE**: Timer0 Source Edge Select bit

1 = Increment on high-to-low transition on the T0CKI pin

0 = Increment on low-to-high transition on the T0CKI pin

bit 3 **PSA**: Prescaler Assignment bit

1 = Prescaler assigned to the WDT

0 = Prescaler assigned to Timer0

bit 2-0 **PS<2:0>**: Prescaler Rate Select bits

| Bit Value | Timer0 Rate | WDT Rate |
|-----------|-------------|----------|
| 000 | 1 : 2 | 1 : 1 |
| 001 | 1 : 4 | 1 : 2 |
| 010 | 1 : 8 | 1 : 4 |
| 011 | 1 : 16 | 1 : 8 |
| 100 | 1 : 32 | 1 : 16 |
| 101 | 1 : 64 | 1 : 32 |
| 110 | 1 : 128 | 1 : 64 |
| 111 | 1 : 256 | 1 : 128 |

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TABLE 5-1: SUMMARY OF PORT REGISTERS

| Address | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Value on Power-On Reset | Value on All Other Resets |
|---------|-------------------------|-------|-------|----------------------|-----------------|-----------------|-------|-------|-------|-------------------------|---------------------------|
| N/A | TRISGPIO ⁽¹⁾ | — | — | I/O Control Register | | | | | | --11 1111 | --11 1111 |
| N/A | TRISB ⁽²⁾ | — | — | I/O Control Register | | | | | | --11 1111 | --11 1111 |
| N/A | TRISC ⁽²⁾ | — | — | I/O Control Register | | | | | | --11 1111 | --11 1111 |
| N/A | OPTION ⁽¹⁾ | GPWU | GPPU | TOCS | TOSE | PSA | PS2 | PS1 | PS0 | 1111 1111 | 1111 1111 |
| N/A | OPTION ⁽²⁾ | RBWU | RBPV | TOCS | TOSE | PSA | PS2 | PS1 | PS0 | 1111 1111 | 1111 1111 |
| 03h | STATUS ⁽¹⁾ | GPWUF | — | PAO | \overline{TO} | \overline{PD} | Z | DC | C | 0-01 1xxx | q00q quuu ⁽³⁾ |
| 03h | STATUS ⁽²⁾ | RBWUF | — | PAO | \overline{TO} | \overline{PD} | Z | DC | C | 0-01 1xxx | q00q quuu ⁽³⁾ |
| 06h | GPIO ⁽¹⁾ | — | — | GP5 | GP4 | GP3 | GP2 | GP1 | GP0 | --xx xxxx | --uu uuuu |
| 06h | PORTB ⁽²⁾ | — | — | RB5 | RB4 | RB3 | RB2 | RB1 | RB0 | --xx xxxx | --uu uuuu |
| 07h | PORTC ⁽²⁾ | — | — | RC5 | RC4 | RC3 | RC2 | RC1 | RC0 | --xx xxxx | --uu uuuu |

Legend: Shaded cells are not used by Port registers, read as '0'. — = unimplemented, read as '0', x = unknown, u = unchanged, q = depends on condition.

Note 1: PIC12F508/509 only.

Note 2: PIC16F505 only.

Note 3: If Reset was due to wake-up on pin change, then bit 7 = 1. All other Resets will cause bit 7 = 0.

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6.2 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module or as a postscaler for the Watchdog Timer (WDT), respectively (see **Section 7.6 “Watchdog Timer (WDT)”**). For simplicity, this counter is being referred to as “prescaler” throughout this data sheet.

Note: The prescaler may be used by either the Timer0 module or the WDT, but not both. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the WDT and vice versa.

The PSA and PS<2:0> bits (OPTION<3:0>) determine prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g., CLRF 1, MOVWF 1, BSF 1, x, etc.) will clear the prescaler. When assigned to WDT, a CLRWDW instruction will clear the prescaler along with the WDT. The prescaler is neither readable nor writable. On a Reset, the prescaler contains all ‘0’s.

6.2.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control (i.e., it can be changed “on-the-fly” during program execution). To avoid an unintended device Reset, the following instruction sequence (Example 6-1) must be executed when changing the prescaler assignment from Timer0 to the WDT.

EXAMPLE 6-1: CHANGING PRESCALER (TIMER0 → WDT)

```
CLRWDW          ;Clear WDT
CLRF    TMR0     ;Clear TMR0 & Prescaler
MOVLW  '00xx1111'b ;These 3 lines (5, 6, 7)
OPTION          ;are required only if
                ;desired
CLRWDW          ;PS<2:0> are 000 or 001
MOVLW  '00xx1xxx'b ;Set Postscaler to
OPTION          ;desired WDT rate
```

To change the prescaler from the WDT to the Timer0 module, use the sequence shown in Example 6-2. This sequence must be used even if the WDT is disabled. A CLRWDW instruction should be executed before switching the prescaler.

EXAMPLE 6-2: CHANGING PRESCALER (WDT → TIMER0)

```
CLRWDW          ;Clear WDT and
                ;prescaler
MOVLW  'xxxx0xxx' ;Select TMR0, new
                ;prescale value and
                ;clock source
OPTION
```

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NOTES:

7.3 Reset

The device differentiates between various kinds of Reset:

- Power-on Reset (POR)
- $\overline{\text{MCLR}}$ Reset during normal operation
- $\overline{\text{MCLR}}$ Reset during Sleep
- WDT time-out Reset during normal operation
- WDT time-out Reset during Sleep
- Wake-up from Sleep on pin change

Some registers are not reset in any way, they are unknown on POR and unchanged in any other Reset. Most other registers are reset to “Reset state” on Power-on Reset (POR), $\overline{\text{MCLR}}$, WDT or Wake-up on pin change Reset during normal operation. They are not affected by a WDT Reset during Sleep or $\overline{\text{MCLR}}$ Reset during Sleep, since these Resets are viewed as resumption of normal operation. The exceptions to this are $\overline{\text{TO}}$, $\overline{\text{PD}}$ and RBWUF/GPWUF bits. They are set or cleared differently in different Reset situations. These bits are used in software to determine the nature of Reset. See Table 7-4 for a full description of Reset states of all registers.

TABLE 7-3: RESET CONDITIONS FOR REGISTERS – PIC12F508/509

| Register | Address | Power-on Reset | $\overline{\text{MCLR}}$ Reset, WDT Time-out, Wake-up On Pin Change |
|--------------------|---------|--------------------------------|---|
| W | — | q q q q q q q u ⁽¹⁾ | q q q q q q q u ⁽¹⁾ |
| INDF | 00h | x x x x x x x x | u u u u u u u u |
| TMR0 | 01h | x x x x x x x x | u u u u u u u u |
| PC | 02h | 1 1 1 1 1 1 1 1 | 1 1 1 1 1 1 1 1 |
| STATUS | 03h | 0 0 0 1 1 x x x | q 0 0 q q u u u ^{(2), (3)} |
| FSR ⁽⁴⁾ | 04h | 1 1 0 x x x x x | 1 1 u u u u u u |
| FSR ⁽⁵⁾ | 04h | 1 1 1 x x x x x | 1 1 1 u u u u u |
| OSCCAL | 05h | 1 1 1 1 1 1 1 - | u u u u u u u - |
| GPIO | 06h | - - x x x x x x | - - u u u u u u |
| OPTION | — | 1 1 1 1 1 1 1 1 | 1 1 1 1 1 1 1 1 |
| TRIS | — | - - 1 1 1 1 1 1 | - - 1 1 1 1 1 1 |

Legend: u = unchanged, x = unknown, – = unimplemented bit, read as ‘0’, q = value depends on condition.

Note 1: Bits <7:2> of W register contain oscillator calibration values due to MOVLW XX instruction at top of memory.

2: See Table 7-5 for Reset value for specific conditions.

3: If Reset was due to wake-up on pin change, then bit 7 = 1. All other Resets will cause bit 7 = 0.

4: PIC12F509 only.

5: PIC12F508 only.

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TABLE 8-2: INSTRUCTION SET SUMMARY

| Mnemonic, Operands | | Description | Cycles | 12-Bit Opcode | | | Status Affected | Notes |
|---------------------------------------|------|------------------------------|------------------|---------------|------|------|--------------------|---------|
| | | | | MSb | LSb | | | |
| ADDWF | f, d | Add W and f | 1 | 0001 | 11df | ffff | C, DC, Z | 1, 2, 4 |
| ANDWF | f, d | AND W with f | 1 | 0001 | 01df | ffff | Z | 2, 4 |
| CLRF | f | Clear f | 1 | 0000 | 011f | ffff | Z | 4 |
| CLRW | — | Clear W | 1 | 0000 | 0100 | 0000 | Z | |
| COMF | f, d | Complement f | 1 | 0010 | 01df | ffff | Z | |
| DECF | f, d | Decrement f | 1 | 0000 | 11df | ffff | Z | 2, 4 |
| DECFSZ | f, d | Decrement f, Skip if 0 | 1 ⁽²⁾ | 0010 | 11df | ffff | None | 2, 4 |
| INCF | f, d | Increment f | 1 | 0010 | 10df | ffff | Z | 2, 4 |
| INCFSZ | f, d | Increment f, Skip if 0 | 1 ⁽²⁾ | 0011 | 11df | ffff | None | 2, 4 |
| IORWF | f, d | Inclusive OR W with f | 1 | 0001 | 00df | ffff | Z | 2, 4 |
| MOVF | f, d | Move f | 1 | 0010 | 00df | ffff | Z | 2, 4 |
| MOVWF | f | Move W to f | 1 | 0000 | 001f | ffff | None | 1, 4 |
| NOP | — | No Operation | 1 | 0000 | 0000 | 0000 | None | |
| RLF | f, d | Rotate left f through Carry | 1 | 0011 | 01df | ffff | C | 2, 4 |
| RRF | f, d | Rotate right f through Carry | 1 | 0011 | 00df | ffff | C | 2, 4 |
| SUBWF | f, d | Subtract W from f | 1 | 0000 | 10df | ffff | C, DC, Z | 1, 2, 4 |
| SWAPF | f, d | Swap f | 1 | 0011 | 10df | ffff | None | 2, 4 |
| XORWF | f, d | Exclusive OR W with f | 1 | 0001 | 10df | ffff | Z | 2, 4 |
| BIT-ORIENTED FILE REGISTER OPERATIONS | | | | | | | | |
| BCF | f, b | Bit Clear f | 1 | 0100 | bbbf | ffff | None | 2, 4 |
| BSF | f, b | Bit Set f | 1 | 0101 | bbbf | ffff | None | 2, 4 |
| BTFSC | f, b | Bit Test f, Skip if Clear | 1 ⁽²⁾ | 0110 | bbbf | ffff | None | |
| BTFSS | f, b | Bit Test f, Skip if Set | 1 ⁽²⁾ | 0111 | bbbf | ffff | None | |
| LITERAL AND CONTROL OPERATIONS | | | | | | | | |
| ANDLW | k | AND literal with W | 1 | 1110 | kkkk | kkkk | Z | 1 |
| CALL | k | Call Subroutine | 2 | 1001 | kkkk | kkkk | None | |
| CLRWDT | — | Clear Watchdog Timer | 1 | 0000 | 0000 | 0100 | TO, PD | |
| GOTO | k | Unconditional branch | 2 | 101k | kkkk | kkkk | None | |
| IORLW | k | Inclusive OR literal with W | 1 | 1101 | kkkk | kkkk | Z | |
| MOVLW | k | Move literal to W | 1 | 1100 | kkkk | kkkk | None | |
| OPTION | — | Load OPTION register | 1 | 0000 | 0000 | 0010 | None | |
| RETLW | k | Return, place literal in W | 2 | 1000 | kkkk | kkkk | None | |
| SLEEP | — | Go into Standby mode | 1 | 0000 | 0000 | 0011 | TO, PD | |
| TRIS | f | Load TRIS register | 1 | 0000 | 0000 | 0fff | None | 3 |
| XORLW | k | Exclusive OR literal to W | 1 | 1111 | kkkk | kkkk | Z | |

Note 1: The 9th bit of the program counter will be forced to a '0' by any instruction that writes to the PC except for GOTO. See **Section 4.7 "Program Counter"**.

- When an I/O register is modified as a function of itself (e.g. MOVF PORTB, 1), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.
- The instruction TRIS f, where f = 6, causes the contents of the W register to be written to the tri-state latches of PORTB. A '1' forces the pin to a high-impedance state and disables the output buffers.
- If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared (if assigned to TMR0).

DECF Decrement f

Syntax: [*label*] DECF f,d

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

Operation: $(f) - 1 \rightarrow (\text{dest})$

Status Affected: Z

Description: Decrement register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.

INCF Increment f

Syntax: [*label*] INCF f,d

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

Operation: $(f) + 1 \rightarrow (\text{dest})$

Status Affected: Z

Description: The contents of register 'f' are incremented. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.

DECFSZ Decrement f, Skip if 0

Syntax: [*label*] DECFSZ f,d

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

Operation: $(f) - 1 \rightarrow d$; skip if result = 0

Status Affected: None

Description: The contents of register 'f' are decremented. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.
 If the result is '0', the next instruction, which is already fetched, is discarded and a NOP is executed instead making it a two-cycle instruction.

INCFSZ Increment f, Skip if 0

Syntax: [*label*] INCFSZ f,d

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

Operation: $(f) + 1 \rightarrow (\text{dest})$, skip if result = 0

Status Affected: None

Description: The contents of register 'f' are incremented. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.
 If the result is '0', then the next instruction, which is already fetched, is discarded and a NOP is executed instead making it a two-cycle instruction.

GOTO Unconditional Branch

Syntax: [*label*] GOTO k

Operands: $0 \leq k \leq 511$

Operation: $k \rightarrow \text{PC}<8:0>$;
 $\text{STATUS}<6:5> \rightarrow \text{PC}<10:9>$

Status Affected: None

Description: GOTO is an unconditional branch. The 9-bit immediate value is loaded into PC bits <8:0>. The upper bits of PC are loaded from STATUS<6:5>. GOTO is a two-cycle instruction.

IORLW Inclusive OR literal with W

Syntax: [*label*] IORLW k

Operands: $0 \leq k \leq 255$

Operation: $(W) .\text{OR.} (k) \rightarrow (W)$

Status Affected: Z

Description: The contents of the W register are OR'ed with the eight-bit literal 'k'. The result is placed in the W register.

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TRIS **Load TRIS Register**

Syntax: [*label*] TRIS *f*
Operands: *f* = 6
Operation: (*W*) → TRIS register *f*
Status Affected: None
Description: TRIS register '*f*' (*f* = 6 or 7) is loaded with the contents of the *W* register

XORLW **Exclusive OR literal with W**

Syntax: [*label*] XORLW *k*
Operands: $0 \leq k \leq 255$
Operation: (*W*) .XOR. *k* → (*W*)
Status Affected: Z
Description: The contents of the *W* register are XOR'ed with the eight-bit literal '*k*'. The result is placed in the *W* register.

XORWF **Exclusive OR W with f**

Syntax: [*label*] XORWF *f*,*d*
Operands: $0 \leq f \leq 31$
 d ∈ [0,1]
Operation: (*W*) .XOR. (*f*) → (*dest*)
Status Affected: Z
Description: Exclusive OR the contents of the *W* register with register '*f*'. If '*d*' is '0', the result is stored in the *W* register. If '*d*' is '1', the result is stored back in register '*f*'.

10.3 Timing Parameter Symbolology and Load Conditions – PIC12F508/509/16F505

The timing parameter symbols have been created following one of the following formats:

- 1. TppS2ppS
- 2. TppS

| | |
|----------------|-----------|
| T | |
| F Frequency | T Time |

Lowercase subscripts (pp) and their meanings:

| | | |
|-----------|--------------------|-----------------------------|
| pp | | |
| 2 | to | mc $\overline{\text{MCLR}}$ |
| ck | CLKOUT | osc Oscillator |
| cy | Cycle time | os OSC1 |
| drt | Device Reset Timer | t0 T0CKI |
| io | I/O port | wdt Watchdog Timer |

Uppercase letters and their meanings:

| | | |
|----------|--------------------------|---------------------|
| S | | |
| F | Fall | P Period |
| H | High | R Rise |
| I | Invalid (high-impedance) | V Valid |
| L | Low | Z High-impedance |

FIGURE 10-3: LOAD CONDITIONS – PIC12F508/509/16F505

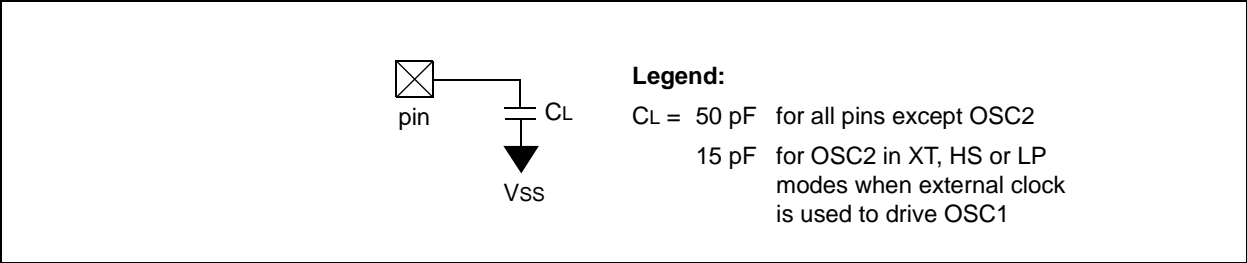
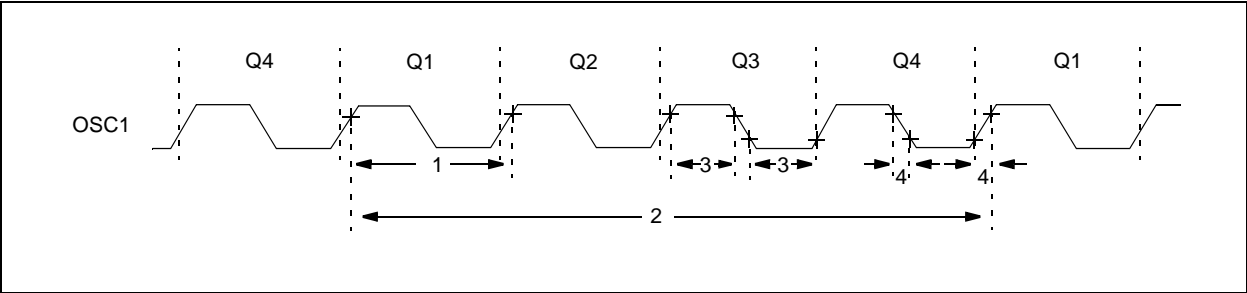


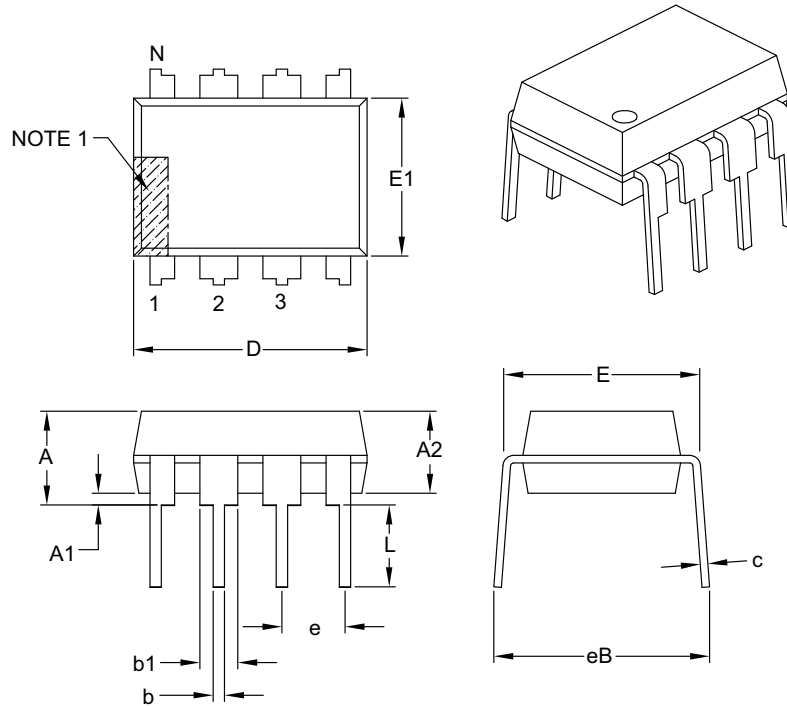
FIGURE 10-4: EXTERNAL CLOCK TIMING – PIC12F508/509/16F505



PIC12F508/509/16F505

8-Lead Plastic Dual In-Line (P) – 300 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Units | | INCHES | | |
|----------------------------|----|----------|------|------|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | N | 8 | | |
| Pitch | e | .100 BSC | | |
| Top to Seating Plane | A | – | – | .210 |
| Molded Package Thickness | A2 | .115 | .130 | .195 |
| Base to Seating Plane | A1 | .015 | – | – |
| Shoulder to Shoulder Width | E | .290 | .310 | .325 |
| Molded Package Width | E1 | .240 | .250 | .280 |
| Overall Length | D | .348 | .365 | .400 |
| Tip to Seating Plane | L | .115 | .130 | .150 |
| Lead Thickness | c | .008 | .010 | .015 |
| Upper Lead Width | b1 | .040 | .060 | .070 |
| Lower Lead Width | b | .014 | .018 | .022 |
| Overall Row Spacing § | eB | – | – | .430 |

Notes:

- Pin 1 visual index feature may vary, but must be located with the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- Dimensioning and tolerancing per ASME Y14.5M.

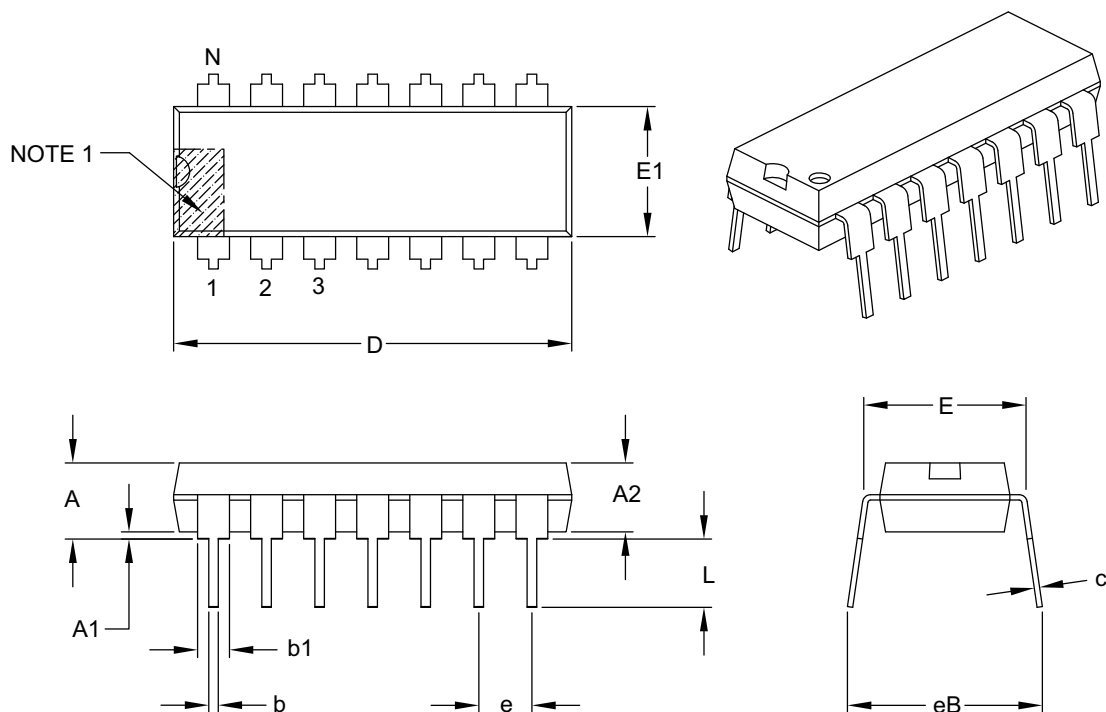
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-018B

PIC12F508/509/16F505

14-Lead Plastic Dual In-Line (P) – 300 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits | Units | INCHES | | |
|----------------------------|-------|----------|------|------|
| | | MIN | NOM | MAX |
| Number of Pins | N | 14 | | |
| Pitch | e | .100 BSC | | |
| Top to Seating Plane | A | – | – | .210 |
| Molded Package Thickness | A2 | .115 | .130 | .195 |
| Base to Seating Plane | A1 | .015 | – | – |
| Shoulder to Shoulder Width | E | .290 | .310 | .325 |
| Molded Package Width | E1 | .240 | .250 | .280 |
| Overall Length | D | .735 | .750 | .775 |
| Tip to Seating Plane | L | .115 | .130 | .150 |
| Lead Thickness | c | .008 | .010 | .015 |
| Upper Lead Width | b1 | .045 | .060 | .070 |
| Lower Lead Width | b | .014 | .018 | .022 |
| Overall Row Spacing § | eB | – | – | .430 |

Notes:

- Pin 1 visual index feature may vary, but must be located with the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- Dimensioning and tolerancing per ASME Y14.5M.

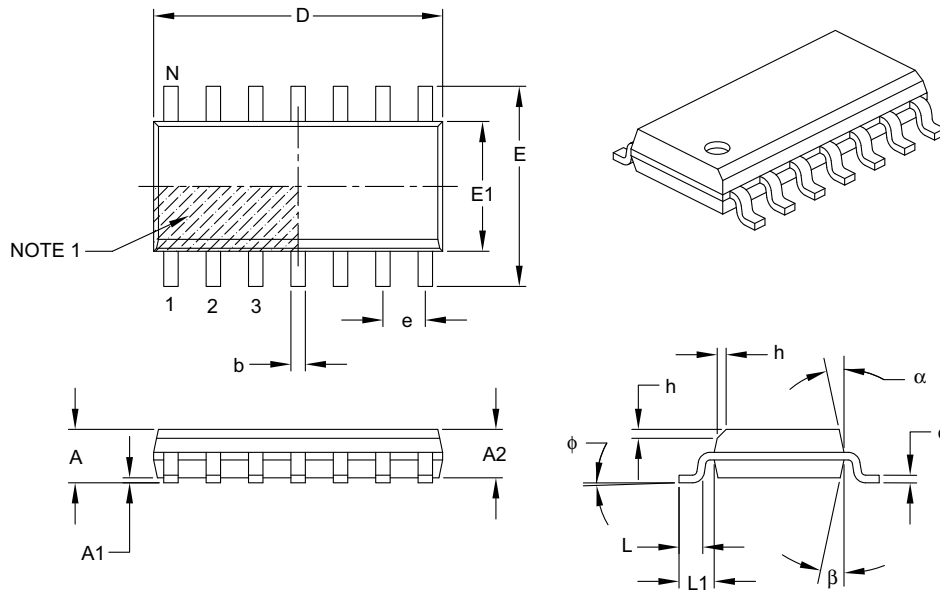
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-005B

PIC12F508/509/16F505

14-Lead Plastic Small Outline (SL) – Narrow, 3.90 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits | Units | MILLIMETERS | | |
|--------------------------|-------|-------------|-----|------|
| | | MIN | NOM | MAX |
| Number of Pins | N | 14 | | |
| Pitch | e | 1.27 BSC | | |
| Overall Height | A | – | – | 1.75 |
| Molded Package Thickness | A2 | 1.25 | – | – |
| Standoff § | A1 | 0.10 | – | 0.25 |
| Overall Width | E | 6.00 BSC | | |
| Molded Package Width | E1 | 3.90 BSC | | |
| Overall Length | D | 8.65 BSC | | |
| Chamfer (optional) | h | 0.25 | – | 0.50 |
| Foot Length | L | 0.40 | – | 1.27 |
| Footprint | L1 | 1.04 REF | | |
| Foot Angle | φ | 0° | – | 8° |
| Lead Thickness | c | 0.17 | – | 0.25 |
| Lead Width | b | 0.31 | – | 0.51 |
| Mold Draft Angle Top | α | 5° | – | 15° |
| Mold Draft Angle Bottom | β | 5° | – | 15° |

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

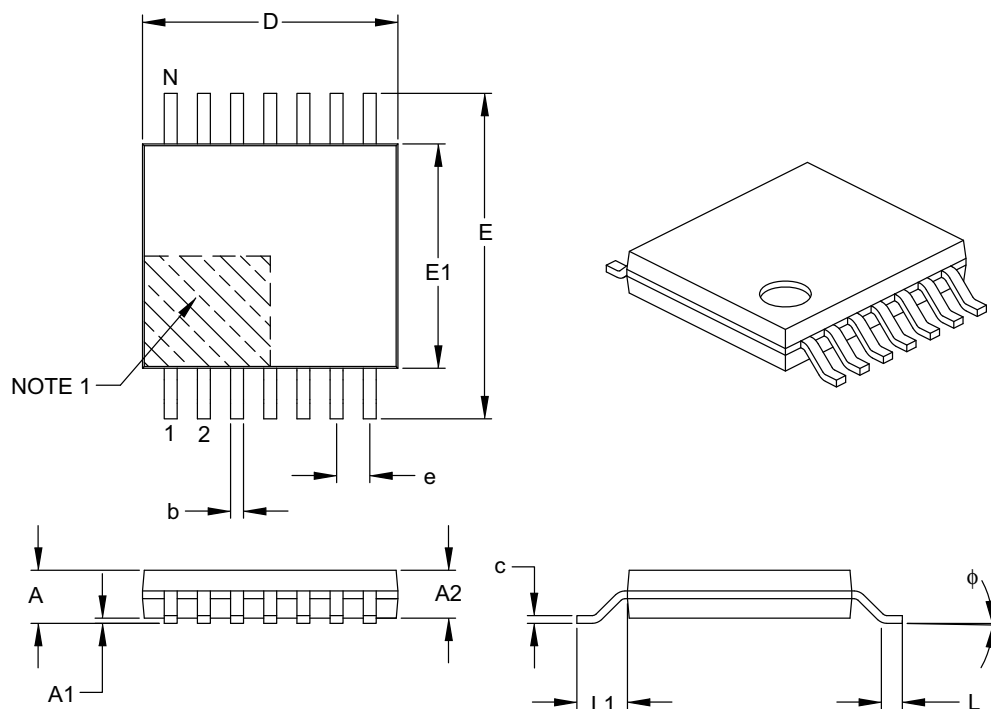
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-065B

PIC12F508/509/16F505

14-Lead Plastic Thin Shrink Small Outline (ST) – 4.4 mm Body [TSSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits | Units | MILLIMETERS | | |
|--------------------------|-------|-------------|------|------|
| | | MIN | NOM | MAX |
| Number of Pins | N | 14 | | |
| Pitch | e | 0.65 BSC | | |
| Overall Height | A | – | – | 1.20 |
| Molded Package Thickness | A2 | 0.80 | 1.00 | 1.05 |
| Standoff | A1 | 0.05 | – | 0.15 |
| Overall Width | E | 6.40 BSC | | |
| Molded Package Width | E1 | 4.30 | 4.40 | 4.50 |
| Molded Package Length | D | 4.90 | 5.00 | 5.10 |
| Foot Length | L | 0.45 | 0.60 | 0.75 |
| Footprint | L1 | 1.00 REF | | |
| Foot Angle | φ | 0° | – | 8° |
| Lead Thickness | c | 0.09 | – | 0.20 |
| Lead Width | b | 0.19 | – | 0.30 |

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-087B

APPENDIX A: REVISION HISTORY

Revision A (April 2004)

Original data sheet for PIC12F508/509/16F505 devices

Revision B (June 2005)

Update packages

Revision C (03/2007)

Revised Table 3-2 Legend; Revised Table 3-3 RB3 and Legend; Revised Table 10-4 F10; Replaced Package Drawings (Rev. AN); Added DFN package; Replaced Development Support Section; Revised Product ID System.

Revision D (12/2007)

Revised Title; Operating Current; Table 1-1 added DFN and revised note; Revised Section 3.0, last paragraph; Revised Figure 4-4; Revised Table 4-2 (FSR); Revised Register 7-1 and Register 7-2; Revised Section 7.2.2; Revised Table 7-3, Note 2; Revised Table 7-4 (FSR) and Note 2; Deleted Section 7.3.1: External Clock In and Figure 7-6; Revised new Section 7.3.1; Replaced TBD with new data in Tables 10-4 and 10-5; Revised Tables 10-1 (Industrial), 10-2 (Extended), and Tables 10-1 (Industrial, Extended) and 10-2 (Pull-up Resistor Ranges), 10-3, 10-4 and 10-6; Revised Figure 10-1, Figure 10-2; Section 11.0, Added Char data; Revised Package Marking Information; Revised Product ID System.

Revision E (08/2009)

Added PIC16F505 16-Pin diagram (QFN); Added Note after subsection 5.2 PORTC; Updated Note 4 and deleted Note 5, Table 10-1; Deleted Param. No. D061 (Table 10-1) and Param. No. D061A becomes D061; Added QFN Package Information; Revised Product Identification System; Added Figures 11-14, 11-15, 11-16, 11-7 to Char Data section; Other minor corrections; Removed Preliminary status.

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